### CD4011A, CD4012A, CD4023A Types

# CMOS NAND Gates

Quad 2 Input - CD4011A Dual 4 Input - CD4012A Triple 3 Input - CD4023A

The TI-CD4011A, CD4012A, and CD-4023A NAND gates provide the system designer with direct implementation of the NAND function and supplement the existing family of CMOS gates.

These types are supplied in 14-lead hermetic dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic packages (E suffix), 14-lead ceramic flat packages (K suffix), and in chip form (H suffix).

#### MAXIMUM RATINGS, Absolute-Maximum Values:

#### STORAGE-TEMPERATURE RANGE (Tstg) . . -65 to +150°C OPERATING TEMPERATURE RANGE ITA) PACKAGE TYPES D. F. K. H -55 to +125°C PACKAGE TYPE E . -40 to +85°C DC SUPPLY-VOLTAGE RANGE, (VDD) (Voltages referenced to VSS Terminal): -0.5 to +15 V POWER DISSIPATION PER PACKAGE (PD): FOR TA - -40 to +60°C IPACKAGE TYPE EI FOR TA = +60 to +85°C (PACKAGE TYPE E ) CO Derate Linearly at 12 mW/°C to 200 mW FOR TA = +100 to +125"C (PACKAGE TYPES D, F, K) ... Derate Linearly at 12 mW/°C to 200 mW DEVICE DISSIPATION PER OUTPUT TRANSISTOR

LEAD TEMPERATURE (DURING SOLDERING)

At distance 1/16  $\pm$  1/32 inch (1.69  $\pm$  0.79 mm) from case for 10 s max \*265 C

> TARE IV. (F

> > Fig. 5

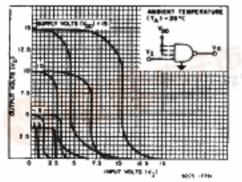
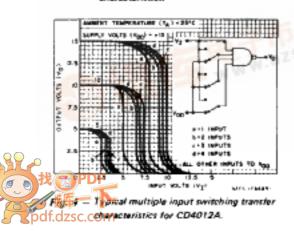


Fig. 2 - Minimum & meximum voltage transfer characteristics.



#### Features:

- Quiescent current specified to 15 V
- Maximum input leakage of 1 µA at 15 V (full package-temperature range)
- 1-V noise margin (full package-temperature range)

RECOMMENDED OPERATING CONDITIONS For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

Characteristic	Min.	Max.	Units
Supply Voltage Range Vover full package temperature range)	3	12	v

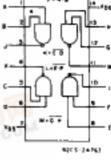
111 - 85% 111171717171

- Typical current & voltage transfer

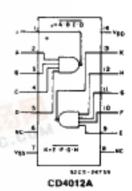
characteristics.

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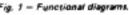


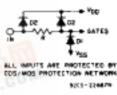
CD4011A

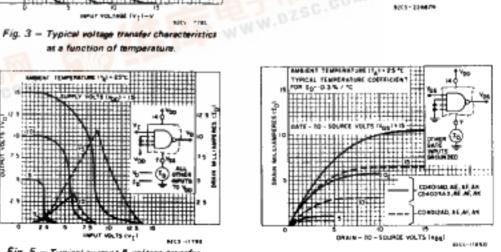




CD4023AH









# CD4011A, CD4012A, CD4023A Types

### STATIC ELECTRICAL CHARACTERISTICS

	Conditions			Limits et Indicated Temperatures (°C)								
Characteristic				D,F,K,H Packages				E Package				Units
	٧o	VIN	VDD	-65	+25		+125	-40	+25		+85	0
	(V)	{V}	(V)	-00	Typ.	Limit			Тур.		_	
Quiescent Device Current, IL Max.	_	-	5	0.05	0.001	0.05	3	0,5	0.005	0.5	15	
	_	_	10	0.1	0.001	0.1	6	5	0.005	5	30	μA
	-	-	15	2	0.02	2	40	50	0.5	50	500	
Output Voltage: Low-Level	-	0,5	5	0 Тур.; 0.05 Мах.								
VOL	-	0,10	10		0 Typ.; 0.05 Max.						. v	
High Level,	-	0,5	5		4.95 Min.; 5 Typ.						•	
VOH	-	0,10	10		9,95 Min.; 10 Typ.							
Noise Immunity: Inputs Low,	3.6	-	5	1.5 Min.; 2.25 Typ.								
VNL	7.2	- ]	10		3 Min.; 4,5 Typ.						v	
Inputs High,	1.4	-	5		1.5 Min.; 2.25 Typ.;						] *	
VNH	2,8	-	10	3 Min.; 4.5 Typ.								
Noise Margin: Inputs Low,	4.5	-	5	1 Min.						v		
VNML	9	-	10	1 Min.								
Inputs High,	0.5	-	5	1 Min.								
VNMH	1	-	10	1 Min.								
Output Drive Current: N-Channel (Sink) IDN Min. CD4011A	0.5	-	5	0.31	0.5	0,25	0.175	0.145	0.5	0.12	0.095	
CD4023A	0.5	-	10	0.62	0.6	0.5	0.35	0.3	0.6	0.25	0,2	
CD4012A	0.5	-	5	0.15	0.25	0.12	0.085	0.072	0.25	0.06	0.05	- mA
	0.5	-	10	0.31	0.6	0.25	0.175	0.155	0.6	0.13	0.105	
P-Channel (Source), IDP Min.	4.5	-	5	.0.31			-0,175	<u> </u>	+		0.095	
All Types	9.5	-	10	-0.75	•1.2	-0.6	-0.4	-0.35	-1.2	-0.3	-0.24	<u> </u>
Input Leakage Current, <sup>1</sup> IL- <sup>1</sup> IH	· ·	iput	15	±10 <sup>-5</sup> Тур.; ±1 Мах.					μА			

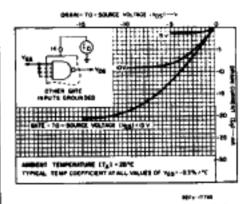
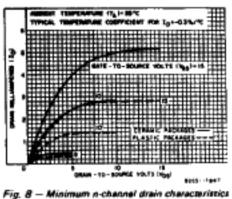
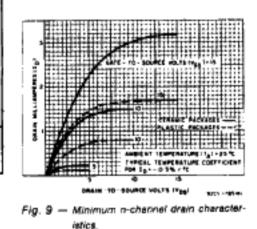
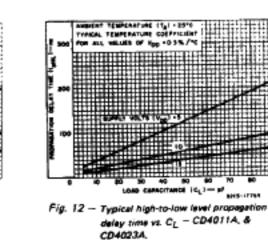


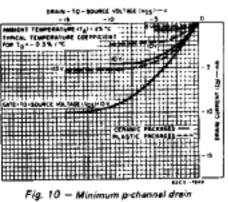
Fig. 7 - Typical p-channel drain characteristics.



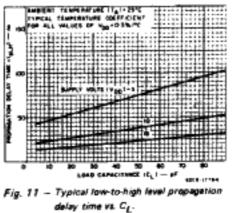
– CD4011A & CD4023A.







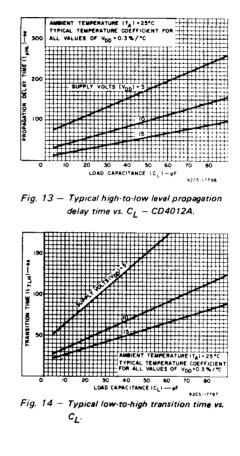
characteristics.

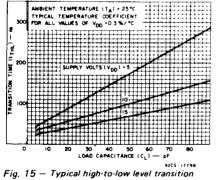


## CD4011A, CD4012A, CD4023A Types

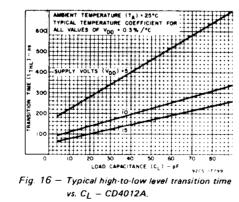
### DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^{\circ}C$ , $C_L = 15 \text{ pF}$ , input t<sub>r</sub>, t<sub>f</sub> = 20 ns, RL = 200 KΩ

	TEST CONDITIONS							
CHARACTERISTICS			D, F, K, H Packages		E Package		UNITS	
		V <sub>DD</sub> (V)	Тур.	Max.	Тур.	Max.		
Propagation Delay Time: Low-to-High Level, tpLH		5	50	75	50	100	ns	
		10	25	40	25	50		
High-to-Low Level, tPHL CD4011A and CD4023A		5	50	75	50	100	ns	
		10	25	40	25	50		
CD4012A		5	100	150	100	200	20	
		10	50	75	50	100		
Transition Time:		5	75	100	75	125		
Low-to-High Level, t <sub>TLH</sub>		10	40	60	40	75	ns	
High-to-Low Level, t <sub>THL</sub> CD4011A and CD4023A		5	75	125	75	150	ля	
		10	50	75	50	100	1 "	
CD4012A		5	250	375	250	500	ns	
		10	125	200	125	250		
Input Capacitance, C <sub>I</sub>	Any In	put	5	_	5	_	pF	

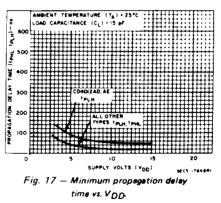


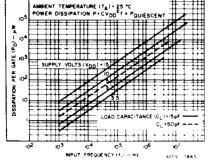


time vs. CL -- CD4011A & CD4023A.



test circuit.







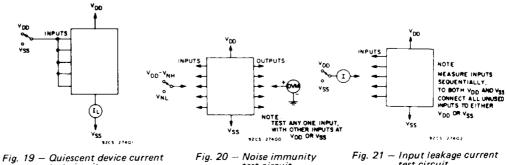


Fig. 20 – Noise immunity test circuit.

Fig. 21 -- Input leakage current test circuit.

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